



## MCHSC705C8ACFNER: Part Detail

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#### **General Information**

Part Number	MCHSC705C8ACFNER
Description	HC05 CORE + 8K RAM + EPR, EPP
Product Line	G7Q5C8A
PTI	MDAC
Material Type	Tested Packaged Device
Life Cycle Description (code)	NOT RECOMMENDED(DECLINING)
Status	Not Recommended for New Design
Application/Qualification Tier	10-YEARS APPLICATION LIFE

#### **Package Information**

Package Type and Termination Count	PLCC 44
Package Description and Mechanical Drawing	PLCC 44
Device Weight(g)	2.38655
Package Material	Plastic
Mounting Style	Surface Mount
Package Length (nominal)(mm)	16.580
Package Width (nominal)(mm)	16.580
Package Thickness (nominal)(mm)	16.580
Tape & Reel	Yes

## **Environmental and Compliance Information**

Pb-Free	(Pb)
RoHS Compliant	√RoHS
Halogen Free	Yes
Material Composition Declaration (MCD)	Download MCD Report Download MCD Report
RoHS Certificate of Analysis (CoA)	Download RoHS CoA Report
2nd Level Interconnect	e3
Moisture Sensitivity Level (MSL)	3

Floor Life	168 HOURS
Peak Package Body Temperature (PPT)(°C)	250
Maximum Time at Peak Temperature (s)	30
Number of Reflow Cycles	3
REACH SVHC	NXP REACH Statement
UL94 (plastics flammability test)	V0;Burning stops within 10 seconds on a vertical specimen;no drips allowed

## Manufacturing Information

Micron Size(µm) 1.2

# **Ordering Information**

Minimum Package Quantity (MPQ)	450
MPQ Container	REEL
Exempt from Minimum Delivery Value	No
Preferred Order Quantity (POQ)	450
POQ Container	BOX
Leadtime (weeks)	8
Export Control Classification Number (US)	EAR99
Harmonized Tariff (US) Disclaimer	8542.31.0000
CCATS Document	-
ENC Status	
Other Trade Compliance Documents	-
Budgetary Price excluding tax(US\$) Change Currency	-
Order	

## **Operating Characteristics**

Sample Exception Availability N

Reliability Data Lookup









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